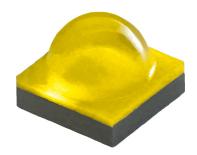
Cree® XLamp® XB-D LEDs





The XLamp® XB-D LED brings next-generation performance, price and size to all LED lighting applications. The XB-D's footprint enables smaller designs with densely packed arrays for better light mixing and concentration.

The XB-D shares common footprint and uniform package design across all white and color configurations, simplifying board and optical designs for many LED systems. The XB-D is optimized to dramatically lower system cost in any illumination application, from indoor and outdoor lighting to architectural and transportation lighting.



FEATURES

- Cree's smallest lighting class LED:
 2.45 X 2.45 mm
- XB-D white binned @ 85 °C; XB-D color binned @ 25 °C
- Up to 136 lm/W in cool white (@ 85 °C, 350 mA)
- Available in white, 80-minimum CRI white, and 70-minimum CRI cool white, royal blue, blue, green, amber, red-orange & red
- 1 A maximum drive current
- Wide viewing angle: from 115° (white) to 140° (red)
- Reflow solderable JEDEC
 J-STD-020C compatible
- Unlimited floor life at
 ≤ 30 °C/85% RH
- · Electrically neutral thermal path
- · RoHS- and REACh-compliant
- UL® recognized component (E349212)



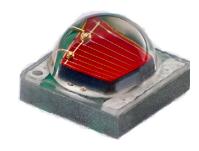


TABLE OF CONTENTS

Characteristics2
Flux Characteristics3
Relative Spectral Power Distribution 6
Relative Flux vs. Junction
Temperature
Electrical Characteristics
Relative Flux vs. Current
Relative Chromaticity vs. Current 10
Relative Chromaticity vs.
Temperature11
Typical Spatial Distribution11
Thermal Design12
Reflow Soldering Characteristics 13
Notes14
Mechanical Dimensions15
Tape and Reel16
Packaging17



CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white, royal blue, blue	°C/W		6.5	
Thermal resistance, junction to solder point - green	°C/W		11	
Thermal resistance, junction to solder point - amber	°C/W		7	
Thermal resistance, junction to solder point - red-orange, red	°C/W		5	
Viewing angle (FWHM) - white	degrees		115	
Viewing angle (FWHM) - royal blue, blue, green	degrees		135	
Viewing angle (FWHM) - amber, red-orange, red	degrees		140	
Temperature coefficient of voltage - white	mV/°C		-2.5	
Temperature coefficient of voltage - royal blue, blue, green	mV/°C		-3.3	
Temperature coefficient of voltage - amber, red-orange, red	mV/°C		-2	
ESD withstand voltage (HBM per Mil-Std-883D) - white, royal blue, blue, green	V			8000
ESD classification (HBM per Mil-Std-883D) - amber, red-orange, red			Class 2	
DC forward current	mA			1000
Reverse voltage	V			-5
Forward voltage (@ 350 mA, 85 °C) - white	V		2.9	3.5
Forward voltage (@ 350 mA, 25 °C) - royal blue, blue	V		3.1	3.7
Forward voltage (@ 350 mA, 25 °C) - green	V		3.3	3.9
Forward voltage (@ 350 mA, 25 °C) - amber, red-orange, red	V		2.25	2.6
LED junction temperature	°C			150



FLUX CHARACTERISTICS - WHITE (T, = 85 °C)

The following table provides several base order codes for XLamp XB-D LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XB-D LED Binning and Labeling document.

0.1	CCT Range		Minimum Luminous Flux @ 350 mA				d Minimum Flux (lm)**	Order Code
Color	Min.	Max.	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	700 mA	1000 mA	Order Code
Cool White	5000 K	8300 K	R3	122	139	210	271	XBDAWT-00-0000-000000F51
Cool White	5000 K	8300 K	R2	114	130	196	253	XBDAWT-00-0000-000000E51
70 CRI Minimum	5000 K	8300 K	R3	122	139	210	271	XBDAWT-00-0000-00000BF51
Cool White	3000 K	6300 K	R2	114	130	196	253	XBDAWT-00-0000-00000BE51
			R2	114	130	196	253	XBDAWT-00-0000-00000LEE4
Neutral White	3700 K	5000 K	Q5	107	122	184	237	XBDAWT-00-0000-00000LDE4
			Q4	100	114	172	222	XBDAWT-00-0000-00000LCE4
			Q4	100	114	172	222	XBDAWT-00-0000-00000HCE7
80 CRI Minimum White	2600 K	6200 K	Q3	93.9	107	162	208	XBDAWT-00-0000-00000HBE7
			Q2	87.4	100	150	194	XBDAWT-00-0000-00000HAE7
			Q4	100	114	172	222	XBDAWT-00-0000-00000LCE7
Warm White	2600 K	0 K 3700 K	Q3	93.9	107	162	208	XBDAWT-00-0000-00000LBE7
			Q2	87.4	100	150	194	XBDAWT-00-0000-00000LAE7

Notes:

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 14).
- Typical CRI for Neutral White, 3700 K 5000K CCT is 75.
- Typical CRI for Warm White, 2600 K 3700 K CCT is 80.
- Minimum CRI for 70 CRI Minimum Cool White is 70.
- Minimum CRI for 80 CRI Minimum White is 80.
- * Flux values @ 25 °C are calculated and are for reference only.
- ** Calculated flux values at 700 mA and 1000 mA are for 85 °C and are for reference only.



FLUX CHARACTERISTICS - COLOR ($T_J = 25$ °C)

The following tables provide several base order codes for XLamp XB-D LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XB-D LED Binning and Labeling document.

	Dominant Wavelength Range				Minimum	n Radiant Flux			
Color	Min.		Max.		(mW) @ 350 mA		Order Code		
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (mW)			
						34 (N)	550	XBDROY-00-0000-000000N01	
									33 (M)
Royal Blue	D36	450	D57	465	32 (L)	500	XBDROY-00-0000-000000L01		
					31 (K)	475	XBDROY-00-0000-000000K01		
				30 (J)	450	XBDROY-00-0000-000000J01			

	Do	minant Wav	elength Rar	nge	Minimum	Minimum Luminous Flux			
Color	M	Min.		Max.		@ 350 mA	Order Code		
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)				
							M2	39.8	XBDBLU-00-0000-000000201
Blue	В3	465	В6	485	K3	35.2	XBDBLU-00-0000-000000Z01		
				K2	30.6	XBDBLU-00-0000-000000Y01			

	Do	minant Wav	elength Rar	nge	Minimum	Luminous Flux		
Color	Min.		Max.		(lm) @ 350 mA		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)			
				535	Q5	107	XBDGRN-00-0000-000000D01	
Green	G2	520	G4		Q4	100	XBDGRN-00-0000-000000C01	
Green	n G2 520 G4	G4	535	Q3	93.9	XBDGRN-00-0000-000000B01		
					Q2	87.4	XBDGRN-00-0000-000000A01	

	Dominant Wavelength Range			Minimum Luminous Flux				
Color	Min.		Max.		(lm) @ 350 mA		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)		
						P3	73.9	XBDAMB-00-0000-00000801
Amahar	40	E0E			XBDAMB-00-0000-000000701			
Amber	Amber A2 585	A3	595	N4	62	XBDAMB-00-0000-000000601		
					N3	56.8	XBDAMB-00-0000-00000501	



FLUX CHARACTERISTICS - COLOR (T $_{\rm J}$ = 25 °C) - CONTINUED

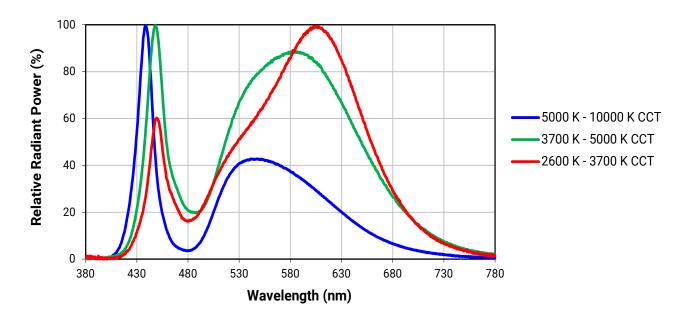
	Dominant Wavelength Range				Minimum	Luminous Flux							
Color	Min.		Max.		(lm) @ 350 mA		Order Code						
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)							
			O4 62	04					Q4	100	XBDRDO-00-0000-000000C01		
									Q3	93.9	XBDRDO-00-0000-000000B01		
Red- Orange	03	610			04	04	04	04 6	620	620	620	Q2	87.4
					P4	80.6	XBDRDO-00-0000-000000901						
				P3	73.9	XBDRDO-00-0000-000000801							

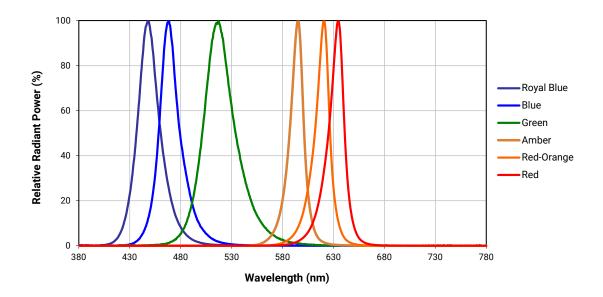
	Dominant Wavelength Range					Luminous Flux					
Color	Min.		M	ax.	(lm) @ 350 mA		(lm) @ 350 mA		(lm) @ 350 mA		Order Code
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)					
							P2	67.2	XBDRED-00-0000-000000701		
Red	R2	620	R3	630	N4	62	XBDRED-00-0000-00000601				
				N3	56.8	XBDRED-00-0000-000000501					

Note: Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements and ± 1 nm on dominant wavelength measurements. See the Measurements section (page 14).



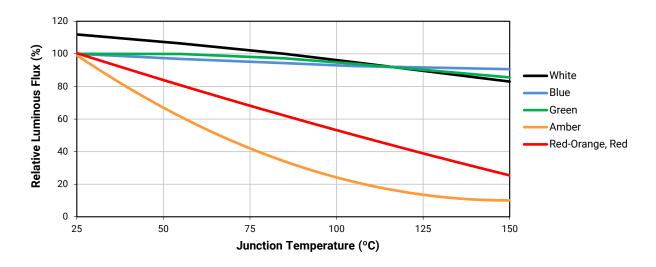
RELATIVE SPECTRAL POWER DISTRIBUTION

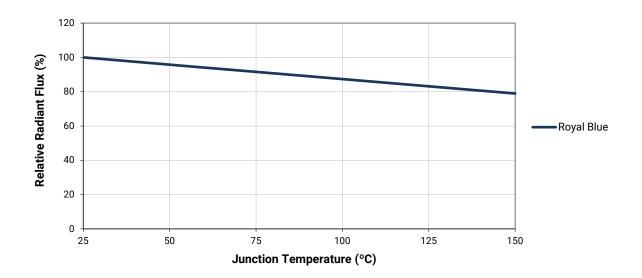






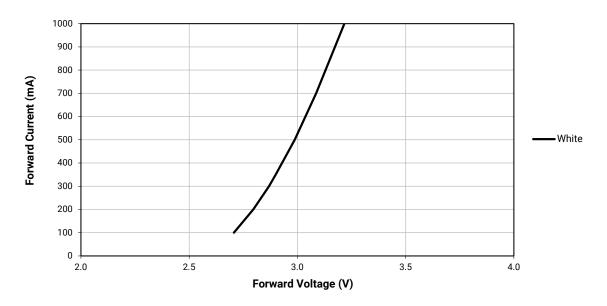
RELATIVE FLUX VS. JUNCTION TEMPERATURE (I_F = 350 mA)



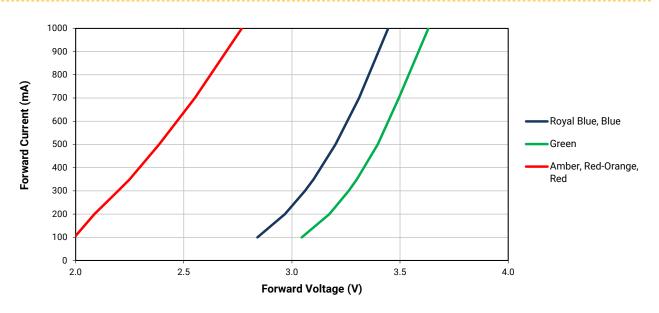




ELECTRICAL CHARACTERISTICS (T₁ = 85 °C)

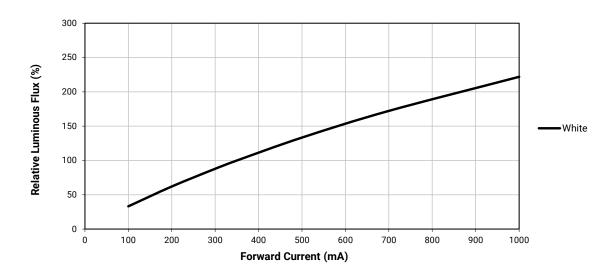


ELECTRICAL CHARACTERISTICS (T_j = 25 °C)

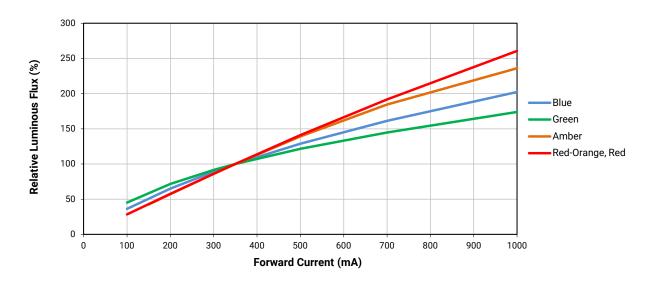




RELATIVE FLUX VS. CURRENT (T $_{\rm J}$ = 85 °C)

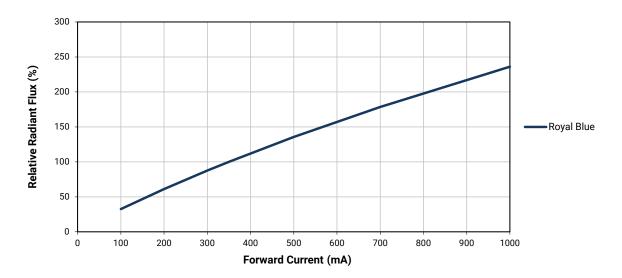


RELATIVE FLUX VS. CURRENT (T₁ = 25 °C)

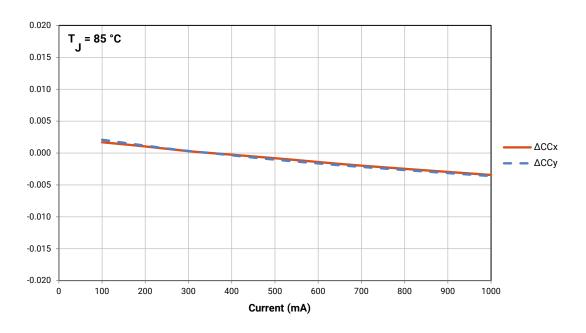




RELATIVE FLUX VS. CURRENT (T_J = 25 °C) - CONTINUED

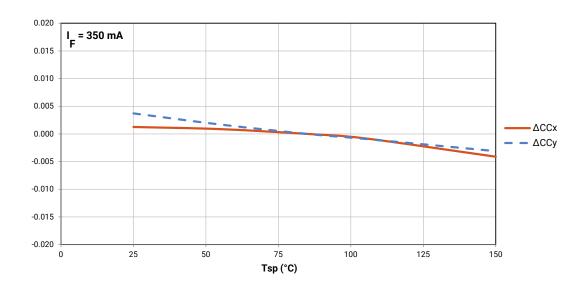


RELATIVE CHROMATICITY VS. CURRENT (WARM WHITE)

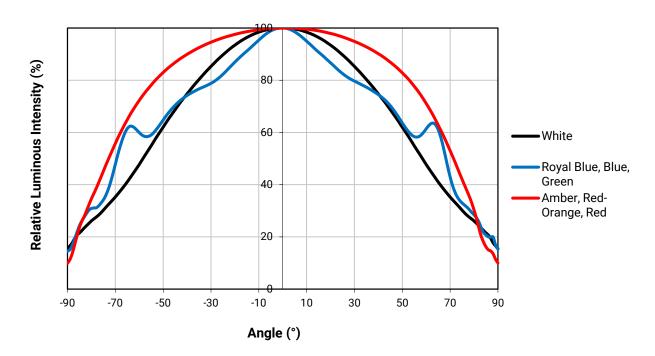




RELATIVE CHROMATICITY VS. TEMPERATURE (WARM WHITE)



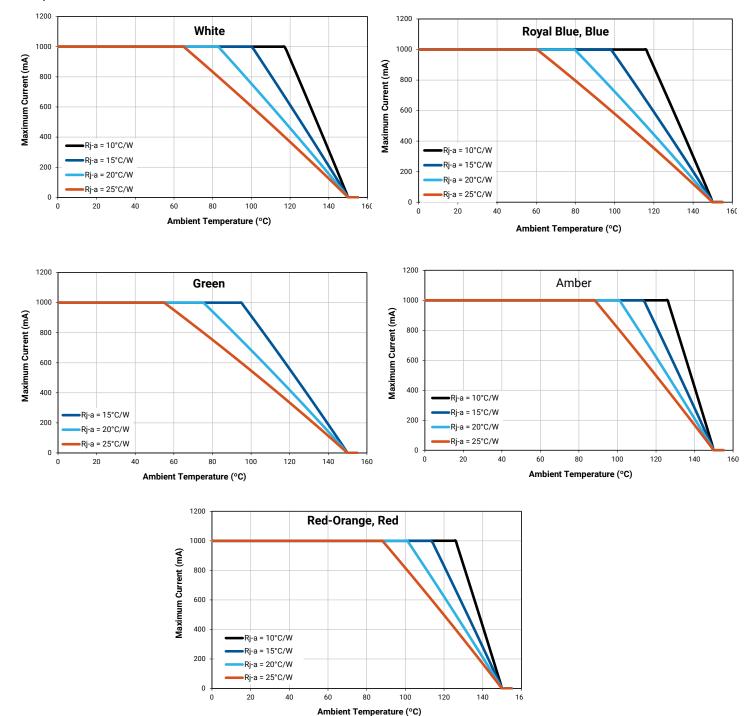
TYPICAL SPATIAL DISTRIBUTION





THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

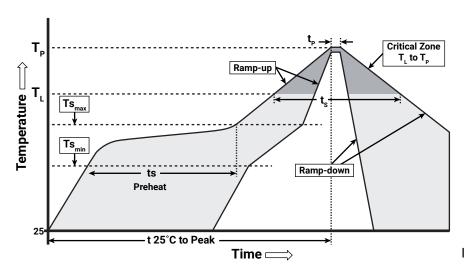




REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XB-D LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (Ts _{min})	100 °C	150 °C
Preheat: Temperature Max (Ts _{max})	150 °C	200 °C
Preheat: Time (ts _{min} to ts _{max})	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T_L)	183 °C	217 °C
Time Maintained Above: Time (t _L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



NOTES

Measurements

The luminous flux, radiant power, chromaticity and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

Lumen Maintenance

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

Cree recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XB-D LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of \leq 30 °C/85% relative humidity (RH). Regardless of storage condition, Cree recommends sealing any unsoldered LEDs in the original MBP.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

REACh Compliance

REACh substances of very high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

UL® Recognized Component

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/ UL 8750.



NOTES - CONTINUED

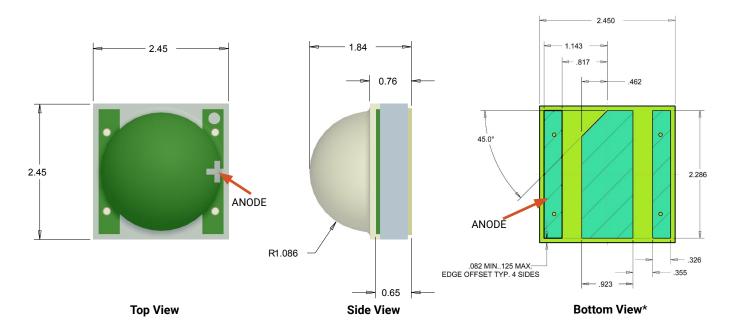
Vision Advisory

WARNING: Do not look at exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

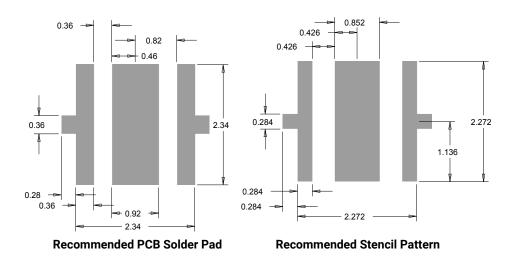


MECHANICAL DIMENSIONS

All measurements are ±.13 mm unless otherwise indicated.



* Note: In December, 2012, Cree changed the thermal pad of the XB-D package to include the anode notch illustrated above. XB-D LEDs produced prior to implementation of this change may have a different visual appearance.



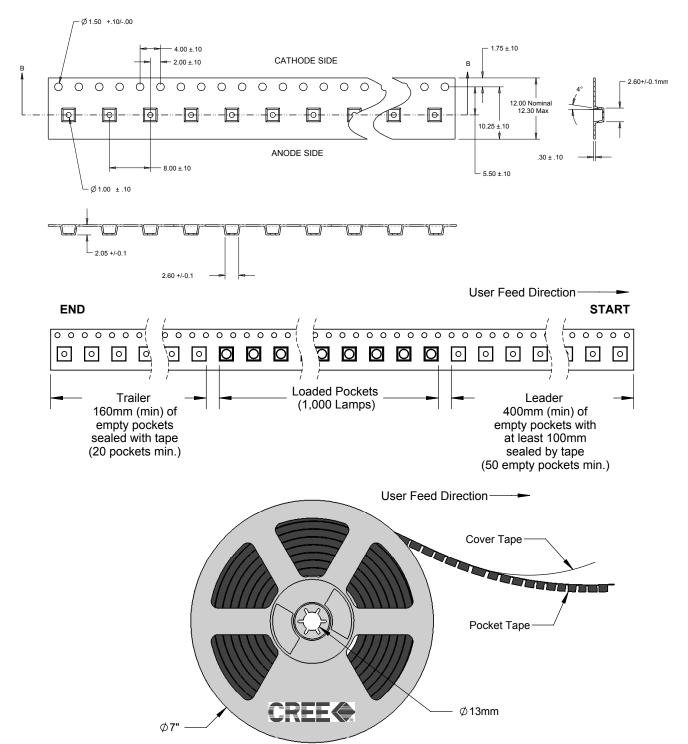


TAPE AND REEL

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

All dimensions in mm

Tolerance unless specified: .xx ± .25, .xxx ± .125, x° ± .5°





PACKAGING

Unpackaged Reel Label with Cree Bin Code,

Quantity, Reel ID

